Hybrid 2z66 Traveler

January 4, 2000

1 Connectivity

Repairs on shorts:

Fixes for opens:

2 Chips

The following chips were assembled on this hybrid (in the order that the chips get read out):
Hybrid 2Z66 has die: 030-008 030-010

3 Data Analysis Summary

The following summarizes the findings of the Burn-in data analysis program. The first chip in the readout name is numbered 0.

```
% Hybrid 2z66 classification info. Created 15:33:25 12/13/99

Hybrid 2z66 quality: fair
Chip classification: good fair
Bad channels: none
Bad cells: none
Random bad capacitors (chip-cell-channel): 1-1-91 1-12-90 1-12-91
   1-13-91 1-3-90 1-3-91 1-39-91 1-40-91 1-42-90 1-42-91 1-43-91
   1-45-91
Channels at pedestal needed for DCMS: 26.6 32.5
```

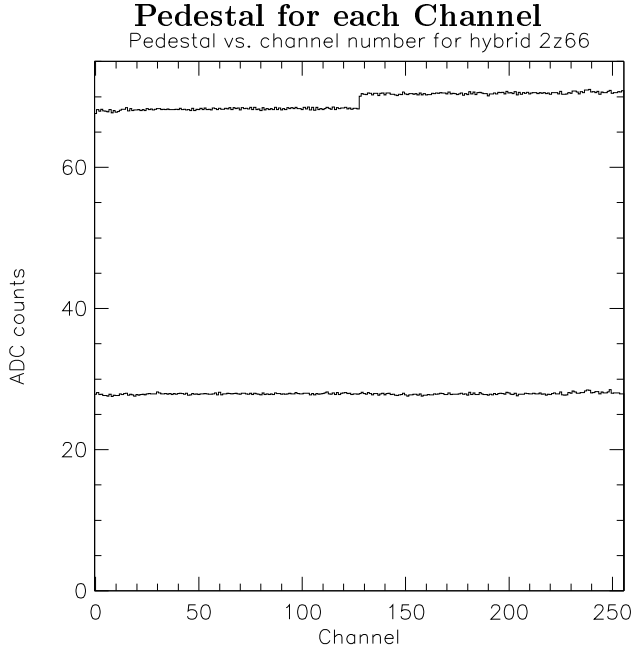
4 Comments

No comments.

5 Pedestal

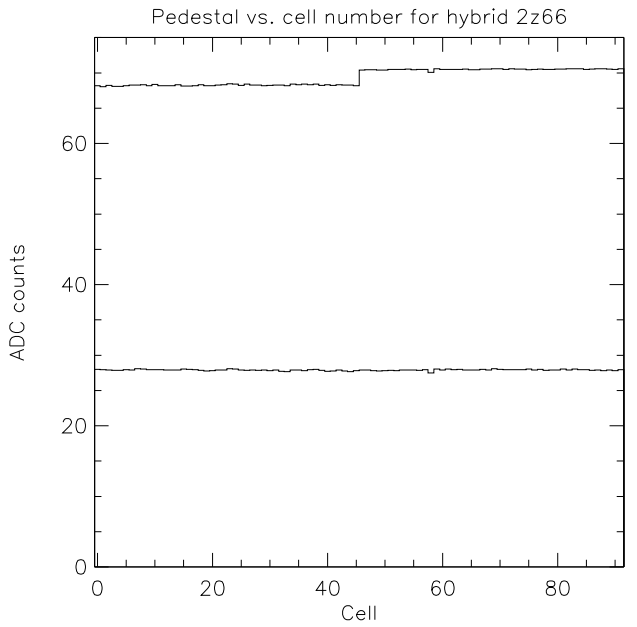
The following plot shows the pedestals vs. channel number with and without charge injection:

Pedestal for each Channel



The following plot shows the average pedestal vs. pipeline cell ID with and without charge injection. The x-axis is cell ID offset by 46 for each chip. Thus cell ID 5 for chip 1 is at x=5, chip 2 at x=51, chip 3 at x=97, etc.

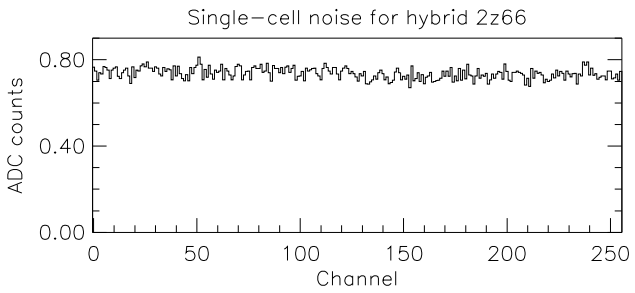
Pedestal vs. Pipeline Cell ID

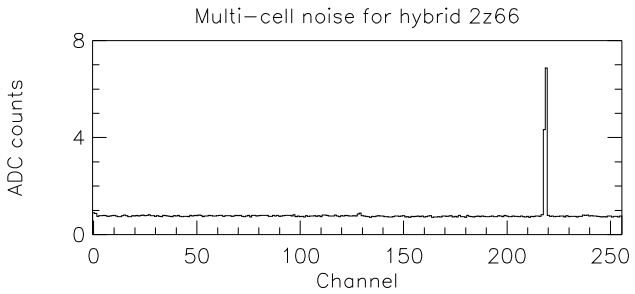


6 Noise

The following plots show the single-cell and multi-cell RMS noise:

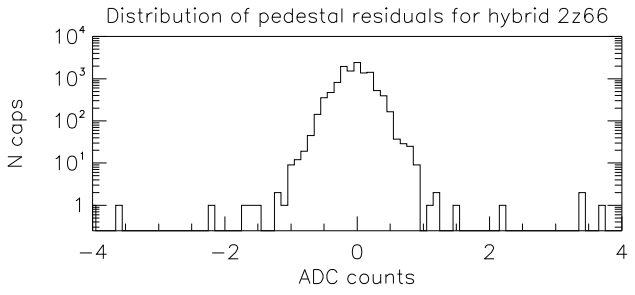
RMS Noise

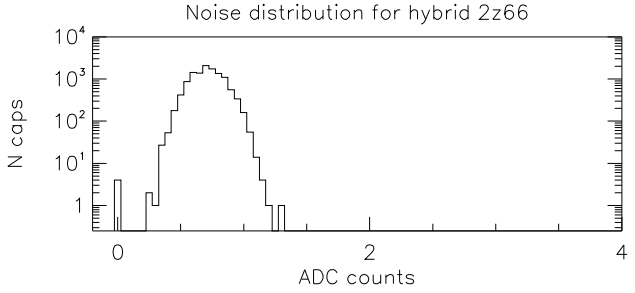




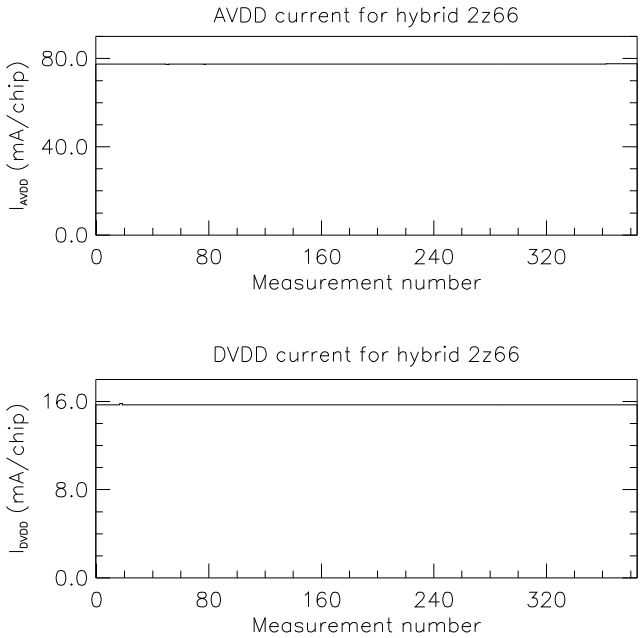
The following are histograms of the pedestal of each pipeline capacitor relative to the chip average (top); and the RMS noise of each capacitor (bottom):

Distribution of Pedestals and Noise





7 Currents

The following plots show the supply currents per chip as a function of measurment number. Currents are measured approximately every 10 minutes:

Supply Currents During Burn-in